

Power management (dual transistors)

UMF4N

2SA2018 and DTC123EE are housed independently in a UMT package.

●Application

Power management circuit

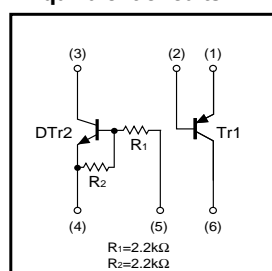
●Features

- 1) Power switching circuit in a single package.
- 2) Mounting cost and area can be cut in half.

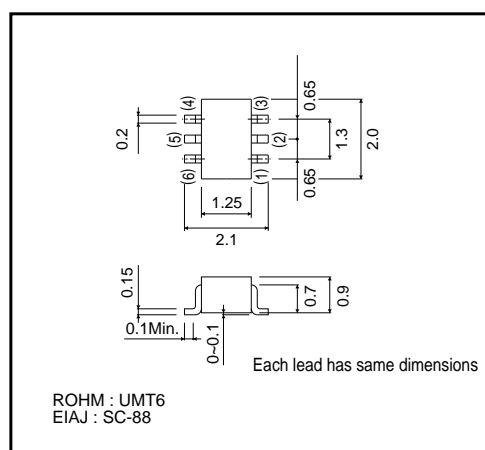
●Structure

Silicon epitaxial planar transistor

●Equivalent circuits



●External dimensions (Units : mm)



●Package, marking, and packaging specifications

| | |
|-----------------------------|-------|
| Type | UMF4N |
| Package | UMT6 |
| Marking | F4 |
| Code | TR |
| Basic ordering unit(pieces) | 3000 |

Transistors

●Absolute maximum ratings (Ta=25°C)

Tr1

| Parameter | Symbol | Limits | Unit |
|------------------------------|------------------|------------|-------|
| Collector-base voltage | V _{CBO} | -15 | V |
| Collector-emitter voltage | V _{CEO} | -12 | V |
| Emitter-base voltage | V _{EBO} | -6 | V |
| Collector current | I _c | -500 | mA |
| | I _{cP} | -1.0 | A *1 |
| Power dissipation | P _c | 150(TOTAL) | mW *2 |
| Junction temperature | T _j | 150 | °C |
| Range of storage temperature | T _{stg} | -55~+150 | °C |

*1 Single pulse P_w=1ms

*2 120mW per element must not be exceeded.

Each terminal mounted on a recommended land.

DTr2

| Parameter | Symbol | Limits | Unit |
|------------------------------|------------------|------------|-------|
| Supply voltage | V _{CC} | 50 | V |
| Input voltage | V _{IN} | -10~+20 | V |
| Collector current | I _c | 100 | mA *1 |
| Output current | I _o | 100 | mA |
| Power dissipation | P _c | 150(TOTAL) | mW *2 |
| Junction temperature | T _j | 150 | °C |
| Range of storage temperature | T _{stg} | -55~+150 | °C |

*1 Characteristics of built-in transistor.

*2 Each terminal mounted on a recommended land.

●Electrical characteristics (Ta=25°C)

Tr1

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|--------------------------------------|----------------------|------|------|------|------|--|
| Collector-emitter breakdown voltage | BV _{CEO} | -12 | - | - | V | I _c =-1mA |
| Collector-base breakdown voltage | BV _{CBO} | -15 | - | - | V | I _c =-10μA |
| Emitter-base breakdown voltage | BV _{EBO} | -6 | - | - | V | I _E =-10μA |
| Collector cut-off current | I _{cBO} | - | - | -100 | nA | V _{CB} =-15V |
| Emitter cut-off current | I _{EBO} | - | - | -100 | nA | V _{EB} =-6V |
| Collector-emitter saturation voltage | V _{CE(sat)} | - | -100 | -250 | mV | I _c =-200mA, I _E =-10mA |
| DC current gain | h _{FE} | 270 | - | 680 | - | V _{CE} =-2V, I _c =-10mA |
| Transition frequency | f _T | - | 260 | - | MHz | V _{CE} =-2V, I _E =10mA, f=100MHz |
| Collector output capacitance | C _{ob} | - | 6.5 | - | pF | V _{CB} =-10V, I _E =0mA, f=1MHz |

DTr2

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|----------------------|--------------------------------|------|------|------|------|--|
| Input voltage | V _{I(off)} | - | - | 0.5 | V | V _{CC} =5V, I _o =100μA |
| | V _{I(on)} | 3.0 | - | - | V | V _O =0.3V, I _o =20mA |
| Output voltage | V _{O(on)} | - | 100 | 300 | mV | V _O =10mA, I _i =0.5mA |
| Input current | I _i | - | - | 3.8 | mA | V _I =5V |
| Output current | I _{O(off)} | - | - | 0.5 | μA | V _{CC} =50V, V _I =0V |
| DC current gain | G _i | 20 | - | - | - | V _O =5V, I _o =20mA |
| Transition frequency | f _T | - | 250 | - | MHz | V _{CE} =10V, I _E =-5mA, f=100MHz * |
| Input resistance | R ₁ | 1.54 | 2.2 | 2.86 | kΩ | - |
| Resistance ratio | R ₂ /R ₁ | 0.8 | 1.0 | 1.2 | - | - |

* Characteristics of built-in transistor.

Transistors

●Electrical characteristic curves

Tr1

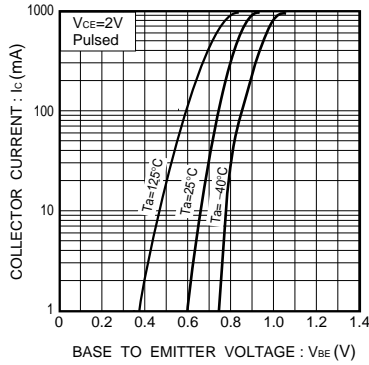


Fig.1 Grounded emitter propagation characteristics

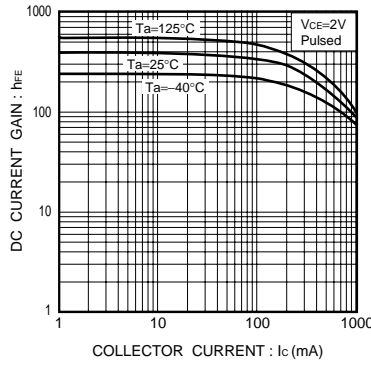


Fig.2 DC current gain vs. collector current

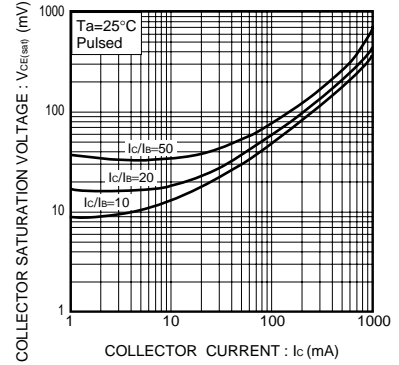


Fig.3 Collector-emitter saturation voltage vs. collector current (I)

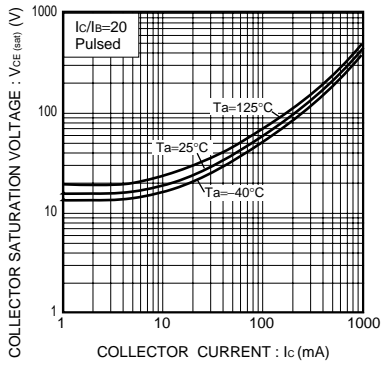


Fig.4 Collector-emitter saturation voltage vs. collector current (II)

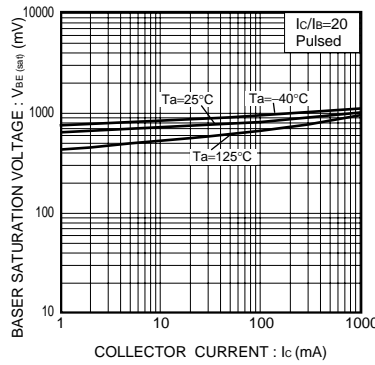


Fig.5 Base-emitter saturation voltage vs. collector current

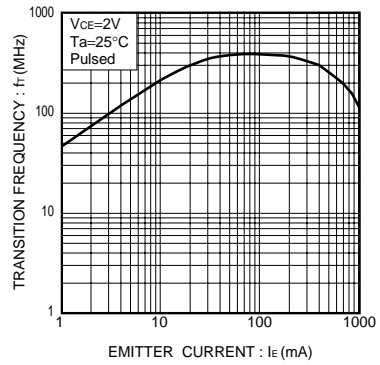


Fig.6 Gain bandwidth product vs. emitter current

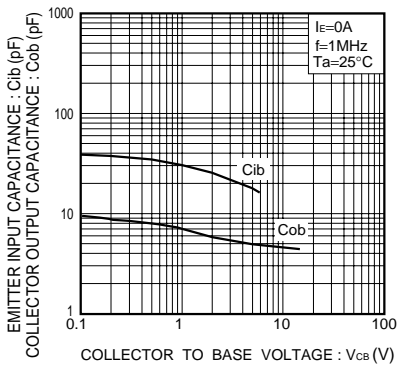


Fig.7 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage

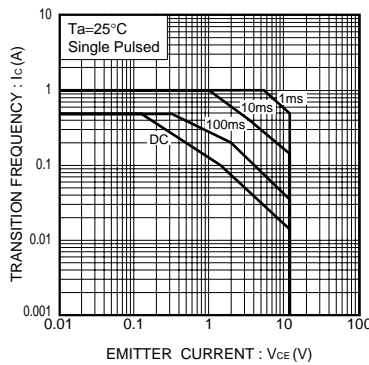


Fig.8 Safe operation area

Transistors

DTr2

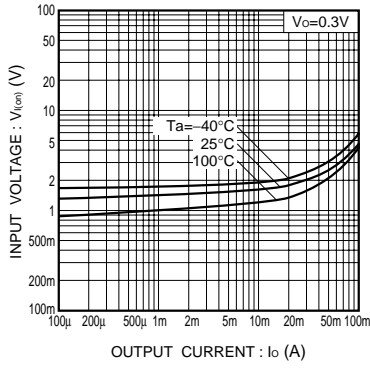


Fig.9 Input voltage vs. output current (ON characteristics)

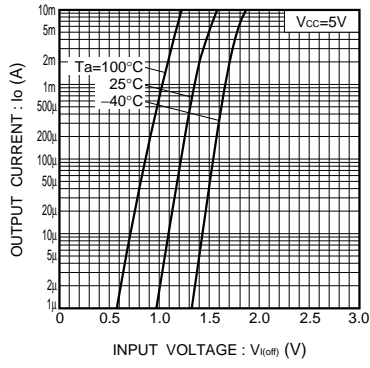


Fig.10 Output current vs. input voltage (OFF characteristics)

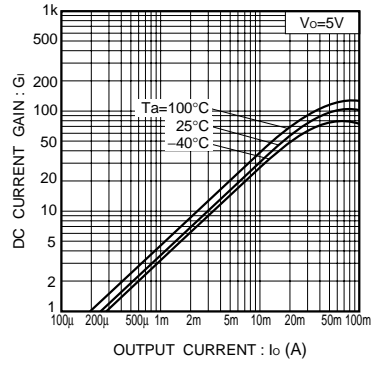


Fig.11 DC current gain vs. output current

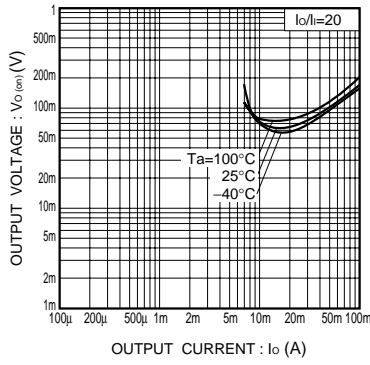


Fig.12 Output voltage vs. output current

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